

# SIM4000

## Sensor Integration Machine

**SICK**  
Sensor Intelligence.



### **Described product**

SIM4000

### **Manufacturer**

SICK AG  
Erwin-Sick-Str. 1  
79183 Waldkirch  
Germany

### **Legal information**

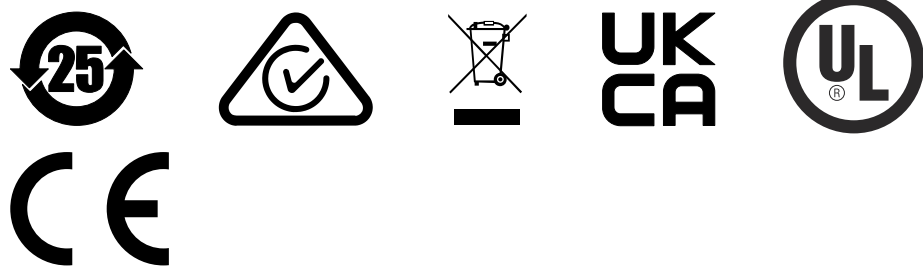
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### **Original document**

This document is an original document of SICK AG.



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# 1 About this document

## 1.1 Information on the operating instructions

These operating instructions provide important information on how to use devices from SICK AG.

Prerequisites for safe work are:

- Compliance with all safety notes and handling instructions supplied.
- Compliance with local work safety regulations and general safety regulations for device applications

The operating instructions are intended to be used by qualified personnel and electrical specialists.



### NOTE

Read these operating instructions carefully to familiarize yourself with the device and its functions before commencing any work.

The operating instructions are an integral part of the product. Store the instructions in the immediate vicinity of the device so they remain accessible to staff at all times. Should the device be passed on to a third party, these operating instructions should be handed over with it.

These operating instructions do not provide information on the handling and safe operation of the machine or system in which the device is integrated. Information on this can be found in the operating instructions for the machine or system.

## 1.2 Explanation of symbols

Warnings and important information in this document are labeled with symbols. Signal words introduce the instructions and indicate the extent of the hazard. To avoid accidents, damage, and personal injury, always comply with the instructions and act carefully.



### DANGER

... indicates a situation of imminent danger, which will lead to a fatality or serious injuries if not prevented.



### WARNING

... indicates a potentially dangerous situation, which may lead to a fatality or serious injuries if not prevented.



### CAUTION

... indicates a potentially dangerous situation, which may lead to minor/slight injuries if not prevented.



### NOTICE

... indicates a potentially harmful situation, which may lead to material damage if not prevented.



### NOTE

... highlights useful tips and recommendations as well as information for efficient and trouble-free operation.

### 1.3 Further information

More information can be found on the product page.

The page can be accessed via the **SICK Product ID: [pid.sick.com/{P/N}/{S/N}](https://pid.sick.com/{P/N}/{S/N})**

**{P/N}** corresponds to the part number of the product, see type label.

**{S/N}** corresponds to the serial number of the product, see type label (if indicated).

**The following information is available depending on the product:**

- Data sheets
- This document in all available language versions
- CAD files and dimensional drawings
- Certificates (e.g., declaration of conformity)
- Other publications
- Software
- Accessories

### 1.4 SICK service

If you require any technical information, our SICK Service will be happy to help. To find your agency, see the final page of this document.



#### **NOTE**

To help us to resolve the matter quickly, please note down the details on the type label.

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## 2 Safety information

### 2.1 General safety notes

The following safety notes must always be observed regardless of specific application conditions:

- The device must only be mounted, commissioned, operated, and maintained by professionally qualified safety personnel.
- Electrical connections with peripheral devices must only be made when the voltage supply is disconnected.
- The device is only to be operated when mounted in a fixed position.
- The device voltage supply must be protected in accordance with the specifications.
- The specified ambient conditions must be observed at all times.
- The electrical connections to peripheral devices must be screwed on correctly.
- The cooling fins must not be covered or restricted in their functionality.
- The pin assignment of pre-assembled cables must be checked and adjusted if necessary.
- These operating instructions must be made available to the operating personnel and kept ready to hand.

### 2.2 Intended use

The device is a programmable control and evaluation unit for sensors and image processing devices. The device also acts as a link between system and plant controls, and the connected terminal devices. The device is mainly used in an industrial environment in production, testing, and control. Other applications are possible depending on the device-specific properties.

The device is programmed on a PC by using the development environment software SICK AppSpace. Depending on the application, a browser-based, graphical user interface (HMI) can be created, which provides opportunities defined by the application developer to influence an application at operator level.

The device connection to the peripherals is established by means of a range of industrial fieldbuses and other interfaces.

The device offers various interfaces for controlling, programming, and operating purposes, which can be activated as necessary via development environments, control systems (programmable logic controllers), or applications.

However, configuration, programming, and control requires various technical skills, depending on how the device is connected and used.

### 2.3 Improper use

Any use outside of the stated areas, in particular use outside of the technical specifications and the requirements for intended use, will be deemed to be incorrect use.

- The device does not constitute a safety component in accordance with the respective applicable safety standards for machines.
- The device must not be used in explosion-hazardous areas, in corrosive environments or under extreme environmental conditions.
- Any use of accessories not specifically approved by SICK AG is at your own risk.



### WARNING

#### Danger due to improper use!

Any improper use can result in dangerous situations.

Therefore, observe the following information:

- Product should be used only in accordance with its intended use.
  - All information in these operating instructions must be strictly observed.
  - Shut down the product immediately in case of damage.
- 

## 2.4 Cybersecurity

### Overview

To protect against cybersecurity threats, it is necessary to continuously monitor and maintain a comprehensive cybersecurity concept. A suitable concept consists of organizational, technical, procedural, electronic, and physical levels of defense and considers suitable measures for different types of risks. The measures implemented in this product can only support protection against cybersecurity threats if the product is used as part of such a concept.

You will find further information at [www.sick.com/psirt](http://www.sick.com/psirt), e.g.:

- General information on cybersecurity
- Contact option for reporting vulnerabilities
- Information on known vulnerabilities (security advisories)

An overview of cybersecurity concepts for the SICK AppSpace Eco-System is available in the SICK Support Portal: [supportportal.sick.com](http://supportportal.sick.com), under the search term: **SICK AppSpace Security Concepts**

## 2.5 Limitation of liability

Relevant standards and regulations, the latest technological developments, and our many years of knowledge and experience have all been taken into account when compiling the data and information contained in these operating instructions. The manufacturer accepts no liability for damage caused by:

- Non-adherence to the product documentation (e.g., operating instructions)
- Incorrect use
- Use of untrained staff
- Unauthorized conversions or repair
- Technical modifications
- Use of unauthorized spare parts, consumables, and accessories



### NOTE

#### Programmable device

The Sensor Integration Machine (SIM) is a programmable device.

Therefore, the respective programmer is responsible for his/her programming performance and the resulting operating principle of the device.

The liability and warranty of SICK AG is limited to the device specification (hardware functionality and any programming interfaces) according to the agreed conditions.

Therefore, SICK AG is not liable, among other things, for damages that are caused by programming of the customer or third parties.

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## 2.6 Modifications and conversions



### NOTICE

Modifications and conversions to the device may result in unforeseeable dangers.

Interrupting or modifying the device or SICK software will invalidate any warranty claims against SICK AG. This applies in particular to opening the housing, even as part of mounting and electrical installation.

## 2.7 Requirements for skilled persons and operating personnel



### WARNING

**Risk of injury due to insufficient training.**

Improper handling of the device may result in considerable personal injury and material damage.

- All work must only ever be carried out by the stipulated persons.

This product documentation refers to the following qualification requirements for the various activities associated with the device:

- **Instructed personnel** have been briefed by the operator about the tasks assigned to them and about potential dangers arising from improper action.
- **Skilled personnel** have the specialist training, skills, and experience, as well as knowledge of the relevant regulations, to be able to perform tasks delegated to them and to detect and avoid any potential dangers independently.
- **Electricians** have the specialist training, skills, and experience, as well as knowledge of the relevant standards and provisions, to be able to carry out work on electrical systems and to detect and avoid any potential dangers independently. The electrician must comply with the provisions of the locally applicable work safety regulation.

The following qualifications are required for various activities:

*Table 1: Activities and technical requirements*

Activities	Qualification
Mounting, maintenance	<ul style="list-style-type: none"> <li>■ Basic practical technical training</li> <li>■ Knowledge of the current safety regulations in the workplace</li> </ul>
Electrical installation, device replacement	<ul style="list-style-type: none"> <li>■ Practical electrical training</li> <li>■ Knowledge of current electrical safety regulations</li> <li>■ Knowledge of the operation and control of the devices in their particular application</li> </ul>
Commissioning, configuration	<ul style="list-style-type: none"> <li>■ Basic knowledge of the computer operating system used</li> <li>■ Basic knowledge of the design and setup of the described connections and interfaces</li> <li>■ Basic knowledge of data transmission</li> </ul>
Operation of the device for the particular application	<ul style="list-style-type: none"> <li>■ Knowledge of the operation and control of the devices in their particular application</li> <li>■ Knowledge of the software and hardware environment for the particular application</li> </ul>

## 2.8 Operational safety and particular hazards

Please observe the safety notes and the warnings listed here and in other chapters of this product documentation to reduce the possibility of risks to health and avoid dangerous situations.

**WARNING****Electrical voltage!**

Electrical voltage can cause severe injury or death.

- Work on electrical systems must only be performed by qualified electricians.
  - The power supply must be disconnected when attaching and detaching electrical connections.
  - The product must only be connected to a voltage supply as set out in the requirements in the operating instructions.
  - National and regional regulations must be complied with.
  - Safety requirements relating to work on electrical systems must be complied with.
- 

**WARNING****Risk of injury and damage caused by potential equalization currents!**

Improper grounding can lead to dangerous equipotential bonding currents, which may in turn lead to dangerous voltages on metallic surfaces, such as the housing. Electrical voltage can cause severe injury or death.

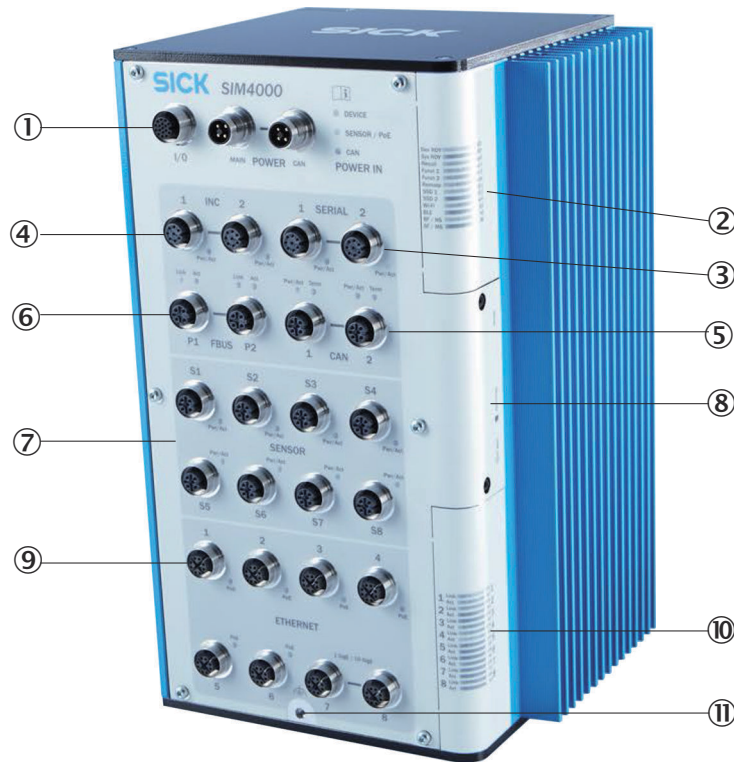
- Work on electrical systems must only be performed by qualified electricians.
  - Follow the notes in the operating instructions.
  - Install the grounding for the product and the system in accordance with national and regional regulations.
- 

### 2.8.1 LED RGO

The product is fitted with LEDs in risk group 0. The accessible radiation from these LEDs does not pose a danger to the eyes or skin.

## 3 Product description

### 3.1 Device view



- ① Power and I/O connections
- ② Device status indicators
- ③ Serial connections
- ④ Incremental connections
- ⑤ CAN connections
- ⑥ Fieldbus connections
- ⑦ (IO-Link) sensor connections
- ⑧ Servicing panel
- ⑨ Ethernet connections
- ⑩ Status indicators for Ethernet and fieldbus connections
- ⑪ Functional ground connection

### 3.2 Functionality

The SIM4000 Sensor Integration Machine – part of the SICK AppSpace ecosystem – is opening up new possibilities for application solutions.

Data from SICK sensors such as laser scanners and cameras can be merged into a point cloud, evaluated, archived, and transmitted. 8 Gigabit Ethernet interfaces are available for 2D or 3D cameras, and in some cases feature a voltage supply over Ethernet (PoE).

Other sensors can be integrated via IO-Link, for example for distance and height measuring purposes.

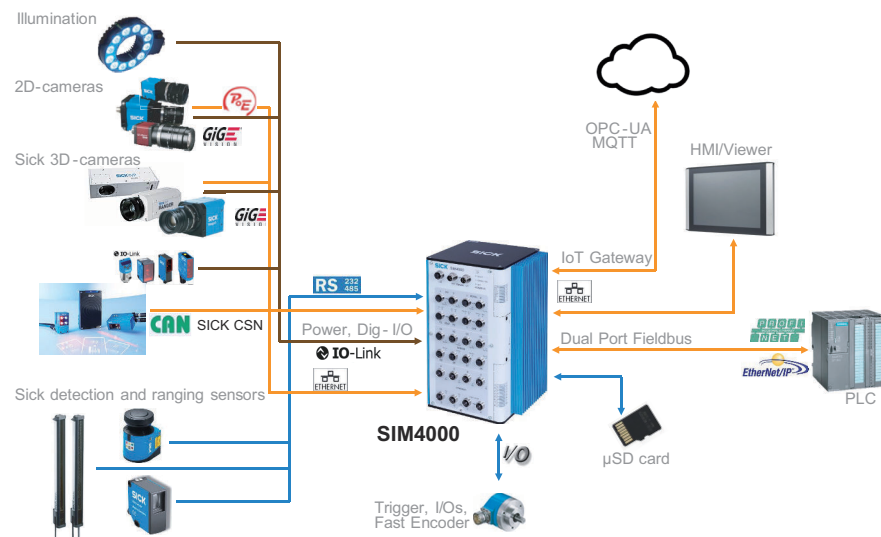
Fieldbus and Ethernet interfaces with OPC-UA and MQTT provide data preprocessed in “dual talk” (edge computing) for the controller and for cloud computing. In addition, the SIM can be integrated into a SICK CAN sensor network.

Thanks to the high-performance multi-core processor featuring hardware support, the SIM4000 enables image (pre)processing and handling of input and output signals in real time. The integrated HALCON image processing library, plus the open SICK AppSpace software platform, make it possible to develop customized application programs for even the most demanding 2D and 3D machine vision applications.

The HMI and data visualization features can be provided on any browser-enabled notebook, PC, or tablet. The app is created using the SICK AppStudio SDKs and - when using HALCON - using HDevelop from MVTec.

### 3.3 Product features and functions

#### 3.3.1 Functions



#### 3.3.2 SICK AppSpace



Detailed instructions on the SICK AppStudio as well as programming the device can be found at [supportportal.sick.com](https://supportportal.sick.com).

### 3.4 Preset Ethernet interfaces



#### NOTE

Preset IP addresses of the ETHERNET interfaces:

- ETHERNET 1: 192.168.0.1
- ETHERNET 2: 192.168.1.1
- ETHERNET 3: 192.168.2.1
- ETHERNET 4: 192.168.3.1
- ETHERNET 5: 192.168.4.1
- ETHERNET 6: 192.168.5.1
- ETHERNET 7: 192.168.6.1
- ETHERNET 8: 192.168.7.1

- When expanding the 1 GigE interfaces with one or more Ethernet switches, it is essential to use only jumbo-frame compatible 1 GigE switches. Switches limited to just 100 Mb/s do not support the data packet mode used by cameras and can cause transmission errors.

**Changing the IP addresses**

The individual IP addresses can be changed using the “WelcomeAPP” pre-installed in the device or via the SICK “SOPAS-ET” PC tool.

After completing the device configuration, it is recommended to remove the WelcomeApp from the device using the SICK AppManager.

### 4 Transport and storage

#### 4.1 Transport

For your own safety, please read and observe the following notes:



##### NOTICE

##### Damage to the product due to improper transport.

- The device must be packaged for transport with protection against shock and damp.
- Recommendation: Use the original packaging as it provides the best protection.
- Transport should be performed by trained specialist staff only.
- The utmost care and attention is required at all times during unloading and transportation on company premises.
- Note the symbols on the packaging.
- Do not remove packaging until immediately before you start mounting.

#### 4.2 Transport inspection

Immediately upon receipt in Goods-in, check the delivery for completeness and for any damage that may have occurred in transit. In the case of transit damage that is visible externally, proceed as follows:

- Do not accept the delivery or only do so conditionally.
- Note the scope of damage on the transport documents or on the transport company's delivery note.
- File a complaint.



##### NOTE

Complaints regarding defects should be filed as soon as these are detected. Damage claims are only valid before the applicable complaint deadlines.

#### 4.3 Storage

Store the device under the following conditions:

- Do not store outdoors.
- Store in a dry area that is protected from dust.
- Do not expose to any aggressive substances.
- Protect from sunlight.
- Avoid mechanical shocks.
- Storage temperature: [see "Technical data", page 40](#).
- For storage periods of longer than 3 months, check the general condition of all components and packaging on a regular basis.

## 5 Mounting

### 5.1 Overview of mounting procedure

**NOTE**

The mounting procedure described here for the device meets the requirements for use in the target system.

Additional or different requirements may become necessary in the laboratory and during preparation, and should be taken into account as necessary, see "Commissioning", page 31. If you have any questions or anything remains unclear in this regard, please contact our service team.

- Mounting the bracket, if provided.
- Mounting the device.
- Connect the cables.
- Connecting peripheral devices.
- Connecting the voltage supply.

### 5.2 Scope of delivery

- SIM4000
- 1x grounding screw
- 1x toothed lock washer
- 6x sliding nuts
- Safety note
- Optional: ordered accessories

**NOTE**

For a list of cables suitable for use with the device, see: [supportportal.sick.com](https://supportportal.sick.com).

The actual scope of delivery may differ for special designs, additional orders or due to the latest technical changes.

### 5.3 Preparing for mounting

**Mounting requirements****NOTE**

It is recommended to mount the device using the adapter holding plate (part no. 2083419) which is available as an accessory. The following specific mounting instructions must be taken into consideration if the device will be used at elevated ambient temperatures up to max. 50 °C, see "Mounting the device (at a critical ambient temperature of max. 50 °C)", page 17.

- Select the mounting site: Plan space requirements and sufficient distance from other devices. Be aware of the possibility of heat dissipation.
- Unpack the device and allow to acclimatise to avoid formation of condensation.

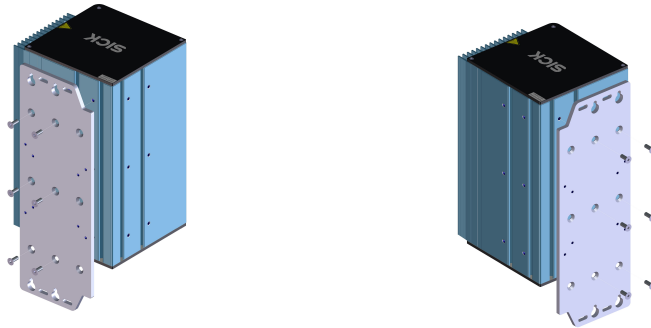
**Preparing for mounting with holding plate****NOTE**

The device can also be mounted onto an aluminum profile without holes.

1. Place the holding plate at the mounting site.
2. Mark the mounting holes.
3. Proceed to drill the mounting holes.

### 5.4 Mounting the device

Mounting the device using the adapter holding plate, available as an accessory



1. Mount the holding plate on SIM4000 using the supplied screws.
2. Place SIM4000 with the holding plate on the mounting site.



3. Secure the holding plate by tightening the 3 screws.





4. Alternatively: Pre-mount the 4 screws for suspended mounting and mount the holding plate with the device.

**NOTICE**

Use self-locking or lock nuts on mounting sites that are exposed to vibrations to prevent the holding plate from loosening.

## 5.5 Mounting the device (at a critical ambient temperature of max. 50 °C)

**NOTICE**

To prevent damage to the device or the attached peripheral devices at high ambient temperatures of a maximum of 50 °C, the following extended installation conditions must be taken into account when mounting the device.

**Prerequisites:**

- Device is mounted vertically (device name on top)
- Mounting takes place using the supplied sliding nuts and the holding plate, which is available as an accessory
- Aluminum profiles for mounting on the system (min. 1,200 mm in length)
- No direct sunlight and heat radiation
- Distance to other components or housing walls: min. 400 mm (above, below, to the left), min. 500 mm (on the heat-sink side)

**Degradation of ambient temperature**

Depending on the following device configurations, degradation of the permitted ambient temperature must be taken into account:

- CPU load  $\geq 75\%$  (can be read using SICK AppStudio)
- PoE load  $\geq 25$  W (load of attached camera)
- Load at voltage/switching outputs  $\geq 100$  W

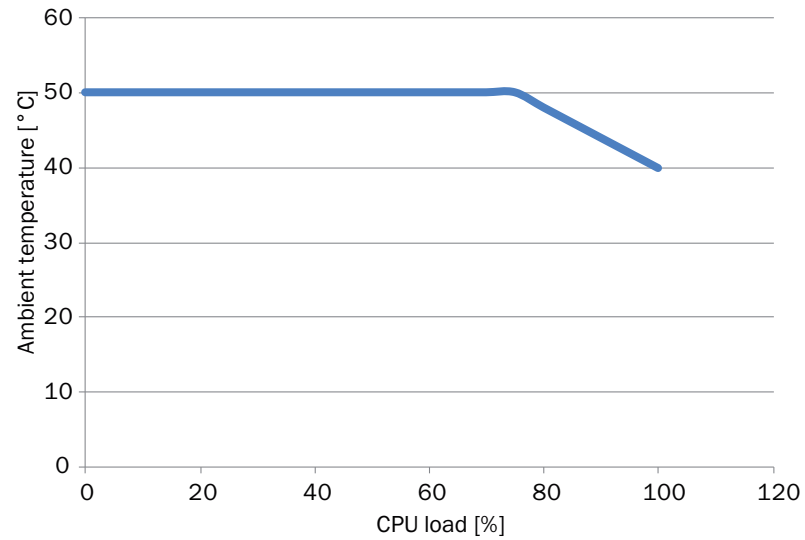


Figure 1: Degradation of ambient temperature depending on the CPU capacity

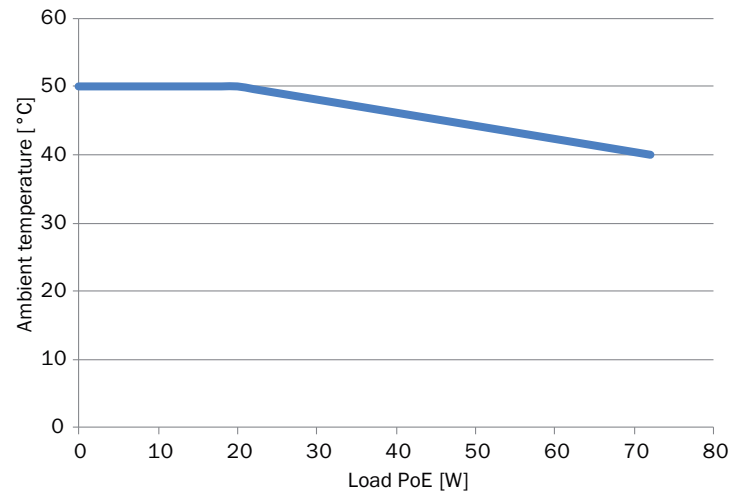


Figure 2: Degradation of ambient temperature depending on the PoE load

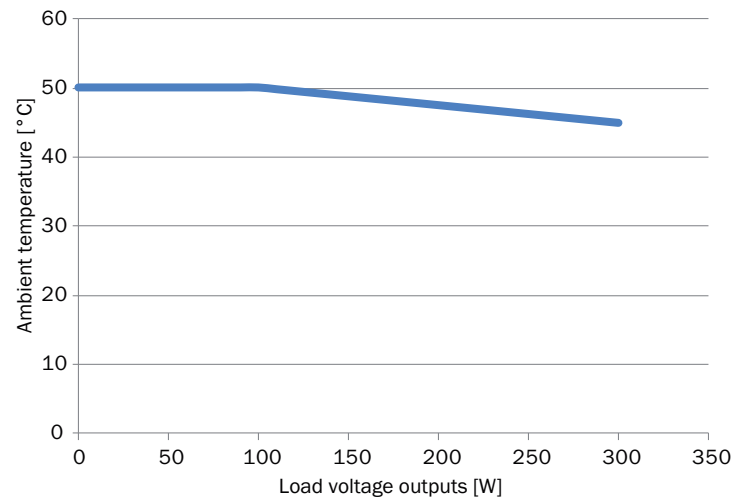
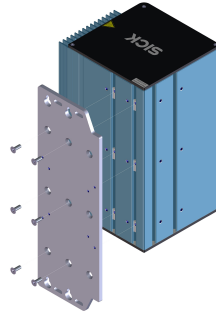


Figure 3: Degradation of ambient temperature depending on the load on the voltage outputs

**Mounting steps**

1. Click the three sliding nuts into place into each of the vertical slots.



2. Screw the holding plate (or equivalent) to the sliding nuts with 6 screws.
3. Fit the device with the holding plate on the aluminum profile.

**CAUTION****Danger from hot surfaces**

An ambient temperature greater than 45 °C can lead to contact-critical heat in the lateral heat sink. It must be therefore be ensured that accidental contact is unlikely.

**NOTE**

Using an external fan (part number 2089755), the maximum ambient operating temperature of the device can be increased from +50 °C to +60 °C. The fan is available as an accessory at [www.sick.com](http://www.sick.com).

## 6 Electrical installation

### 6.1 Important information

**WARNING****Risk of injury and damage caused by electrical current!**

Due to equipotential bonding currents, incorrect earthing can lead to the following dangers and faults: Voltage is applied to the metal housing, cable fires due to cable shields heating up, the product and other devices become damaged.

- Generate the same ground potential at all grounding points.
- Ground the equipotential bonding via the functional ground connection with a low impedance.

**NOTICE****Device damage due to improper supply voltage!**

- Only operate the device with the specified supply voltage.
- The voltage supply and all connected signals must meet the requirements for extra-low voltages with safe separation (SELV) as specified in EN 61010. The external voltage supply of the device must bridge a short-term power interruption of 20 ms in order to meet the requirements of EN 60204-1.
- Only devices that are also supplied with safety extra-low voltage must be connected.

**NOTE****Layout of data cables**

- Use screened data cables with twisted-pair wires.
- Implement the screening design correctly and completely.
- To avoid interference, e.g. from switching power supplies, motors, clocked drives, and contactors, always use cables and layouts that are suitable for EMC.
- Do not lay cables over long distances in parallel with power supply cables and motor cables in cable channels.

### 6.2 Preparing the electrical installation

To carry out the electrical installation, you will need:

- Connection cables for the peripheral devices, including the corresponding data sheets
- Voltage supply cable
- If customers assemble the cables: crimping tool, ferrules, soldering iron, and other installation material

### 6.3 Assembling the cables (optional)

For a list of cables suitable for use with the device, see the document “SIMxxx\_Cable-Overview” available from [supportportal.sick.com](https://supportportal.sick.com).

Customer assembly of the cables is only necessary in special cases. Ensure a sufficient length of cable is provided, e.g., for strain-relief clamps.

**NOTICE****Risk of damage/malfunction due to incorrect PIN assignment**

Incorrect wiring of the male connectors/female connectors can lead to damage to or malfunctions in the system.

- Observe data sheets provided by the cable manufacturer.
- Observe the pin assignment.

## 6.4 Overview of connections

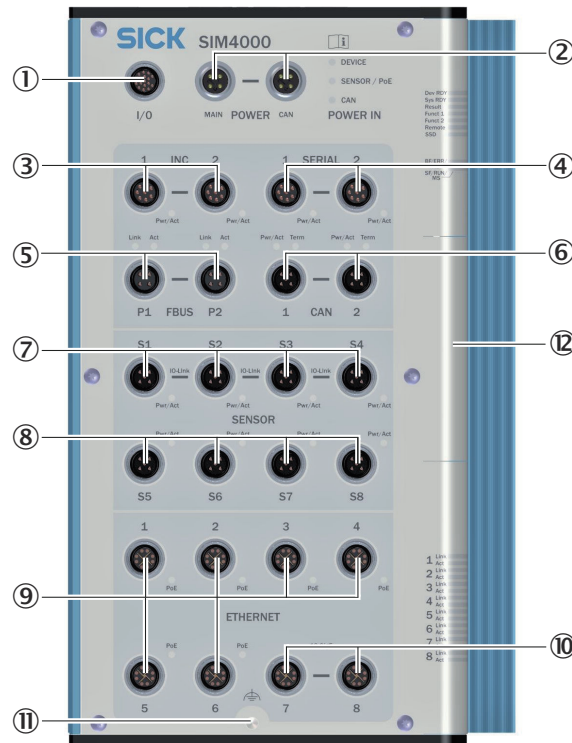


Figure 4: Overview of connections

- ① **I/O:** Universal port with configurable inputs/outputs and opto-decoupled inputs as well as a voltage supply for peripherals
- ② **POWER:** Voltage supply inputs
- ③ **INC:** Two incremental encoder In/Out or RS-422
- ④ **SERIAL:** One RS-232/RS-422/RS-485 or one INC In/Out and one 1 A LPS voltage supply are available for each connection to peripherals
- ⑤ **FBUS:** Two Ethernet-based fieldbus interfaces
- ⑥ **CAN:** Two connections for the SICK CAN sensor network (receiver/transceiver)
- ⑦ **SENSOR 1-4:** 4 sensor connections with digital inputs/outputs and voltage supply, can also be used as IO-Link master connections
- ⑧ **SENSOR 5-8:** Four IO connections with two configurable inputs/outputs and one dedicated input
- ⑨ **ETHERNET:** 6 Ethernet connections ( $\leq 1$  GigE with PoE)
- ⑩ **ETHERNET:** 2 Ethernet connections (10 GigE without PoE)
- ⑪ **Functional earth connection**
- ⑫ **Servicing panel**

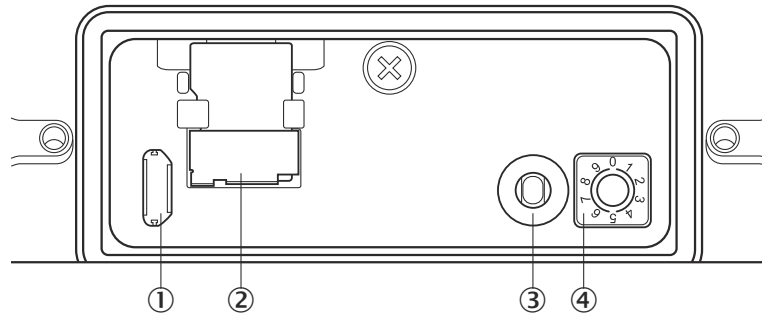


Figure 5: Servicing panel

- ① USB connection (Micro-B, for configuration/diagnostics/firmware update)
- ② microSD card slot
- ③ Function button
- ④ Function selector switch (configurable by SensorApp)

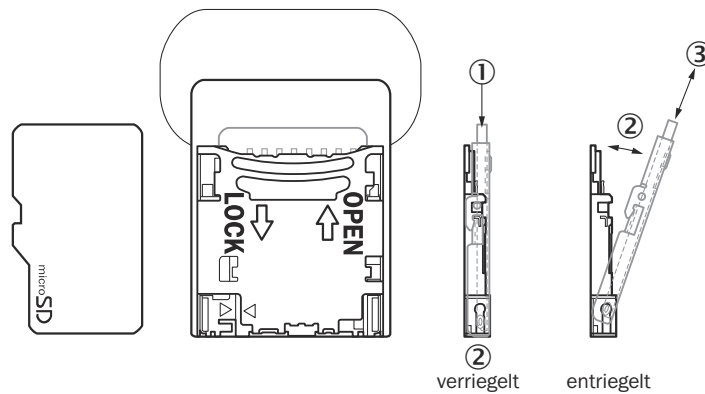


Figure 6: Installing/removing a micro-SD card

- ① Open the servicing panel by removing the two screws.
- ② To install an SD card, first gently press the SD card tray to release ① and then open it ②.
- ③ Now insert the card with the contact side facing down.
- ④ To remove the card, release and open the card tray ② and then pull out the card ③.

### 6.4.1 Functional earth connection



Figure 7: Alternative FE connection

The functional earth (FE) is connected either via the housing/mounting rail or via an FE connection with cable lug.

#### Alternative FE connection

##### Screw connection of the alternative functional earth connection

- Screw: M4 x 15

##### Suitable cable lugs

- Forked cable lug or ring cable lug
- Width  $\leq 10$  mm
- Hole diameter for screw: typically 4.1 mm

The functional earth must be connected in a low-inductance manner and with an adequate cross-section while keeping the cable length as short as possible.

## 6.5 Pin allocation of the connections

### 6.5.1 POWER In main/CAN

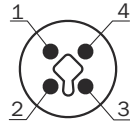


Figure 8: POWER In main/CAN pin assignment, M12 – 4-pin T-coded, male

Table 2: M12 – 4-pin (main, male)

Pin	Signal	Color coding of open-ended SIM cables <sup>1</sup>	Function
1	+24 V IN1 ( $U_s$ )	BN (brown)	Supply voltage, system
2	GND IN2	WH (white)	Ground
3	GND IN1	BU (blue)	Ground
4	+24 V IN2 ( $U_a$ )	BK (black)	Supply voltage for SENSOR S5-S8 + PoE
Housing	–	–	Screen

<sup>1</sup> SICK cables in the SIM4000 accessories

Table 3: M12 – 4-pin (male)

Pin	Signal	Color coding of open-ended SIM cables <sup>1</sup>	Function
1	+24 V IN1 ( $U_s$ )	BN (brown)	Supply voltage, system
2	GND IN2	WH (white)	Ground
3	GND IN1	BU (blue)	Ground
4	+24 V IN2 ( $U_a$ )	BK (black)	Supply voltage, CAN
Housing	–	–	Screen

<sup>1</sup> SICK cables in the SIM4000 accessories

#### Additional notes:

- Max. 7.5 A permanent load per connection (IN1+IN2)
- System supply voltage can be set up redundantly.
- Power cables must be protected with max. 12 A.

## 6.5.2 Connecting voltage supply

### Block diagram

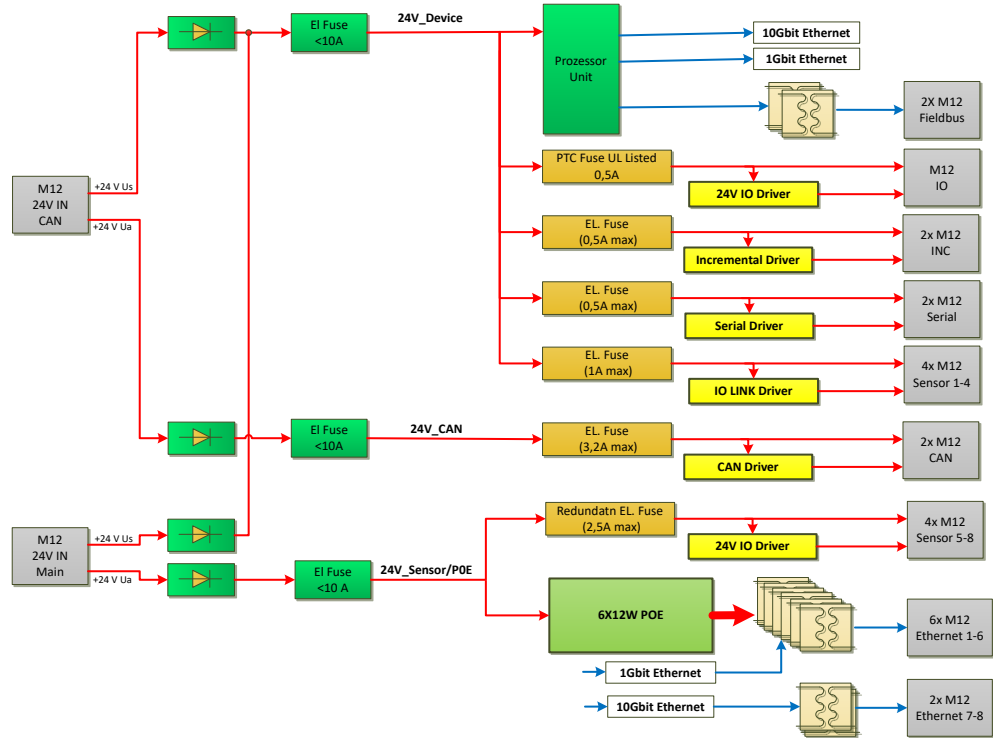


Figure 9: Connection to the power supply



### NOTICE

#### Risk of damage to peripheral devices!

If peripheral devices are connected when the voltage supply is also applied, these devices can become damaged.

- Only connect peripheral devices when the voltage supply is disconnected.

- Ensure that the voltage has been disconnected by the user.
- Connect the voltage supply cable(s) to the device.
- Lay the cable(s) with strain relief.
- Have the user connect the voltage supply.
- Have the user activate the voltage.

## 6.5.3 I/O

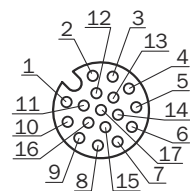


Figure 10: I/O pin assignment, M12 – 17-pin A-coded, female



Table 4: I/O connection

Pin	Signal	Function	Factory settings	Color coding of open-ended SIM I/O cables <sup>1</sup>
1	GND	Ground	–	BU (blue)
2	24 V OUT	Supply voltage, peripherals	Always enabled	BN (brown)
3	Input 5/output 5	Configurable switching input/output	All IO connections as inputs	GN (green)
4	Input 6/output 6	Configurable switching input/output		WH (white)
5	Input 7/output 7	Configurable switching input/output		PK (pink)
6	Input 8/output 8	Configurable switching input/output		BK (black)
7	Input 9/output 9	Configurable switching input/output		BK (black)
8	Input 10/output 10	Configurable switching input/output		GY (gray)
9	Input 11/output 11	Configurable switching input/output		WHBK (white/black)
10	Input 1	Isolated switching input	–	VT (violet)
11	SensGND 1	Isolated GND input 8	–	GYPK (gray/pink)
12	Input 2	Isolated switching input	–	RDBU (red/blue)
13	SensGND 2	Isolated GND input 9	–	WHGN (white/green)
14	Input 3	Isolated switching input	–	BNGN (brown/green)
15	SensGND 3	Isolated GND input 10	–	WHYE (white/yellow)
16	Input 4	Isolated switching input	–	YEEN (yellow/brown)
17	SensGND 4	Isolated GND input 11	–	WHGY (white/gray)
Housing	–	Screen	–	

<sup>1</sup> SICK cables in the SIM4000 accessories

#### Additional notes:

- Connection to control cabinet to connect devices directly
- 7 GPIOs and 4 isolated inputs
- Max. 0.5 A output for supply voltage connection (compliant with LPS)
- Digital outputs can be configured as inputs
- Outputs:
  - Max. current output: 100 mA
  - Min. high output logic level: VCC – 3 V
  - Max. low output logic level: 3 V
  - Push/pull, NPN, PNP configurable
  - Max. output frequency: 10 kHz
- Inputs:
  - Min. high input logic level: 12 V
  - Max. low input logic level: 4 V
  - Input 1 - 4 (isolated): maximum 30 kHz
  - Input 5 - 11: Max. input frequency: 30 kHz

## 6.5.4 INC

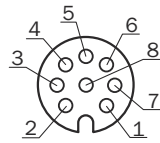


Figure 11: Incremental pin assignment, M12 – 8-pin A-coded, female

Table 5: Incremental connections for encoders, can also be used as serial connections for RS-422

Pin	Mode			
	RS-422*	RS-232	RS-485	INC
1	T-	–	–	A- (in/out)
2	T+	–	–	A+ (in/out)
3	R-	–	–	B- (in/out)
4	R+	–	–	B+ (in/out)
5	–	–	–	Z- (not supported)
6	–	–	–	Z+ (not supported)
7	GND (ground)			
8	24 V (supply voltage for peripherals, configurable, deactivated in factory condition)			
Housing	Screen			

\* Standard configuration

### Additional notes

- Max. 0.5 A output for supply voltage connections (compliant with LPS)
- Frequency: max. 2 MHz
- TTL encoders use RS422 and can be connected via the INC interface.

## 6.5.5 SERIAL

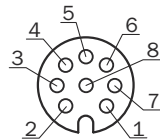


Figure 12: Serial pin assignment, M12 – 8-pin A-coded, female

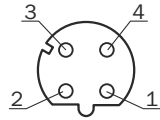
Table 6: Serial connections, can also be used as an incremental connection

Pin	Mode			
	RS-422	RS-232*	RS-485	INC
1	–	–	–	A- (in/out)
2	–	–	–	A+ (in/out)
3	T-	–	Rx/Tx- (B)	B- (in/out)
4	T+	TxD	Rx/Tx+ (A)	B+ (in/out)
5	R-	–		Z- (not supported)
6	R+	RxD		Z+ (not supported)
7	GND (ground)			
8	24 V (supply voltage for peripherals, configurable, deactivated in factory condition)			
Housing	Screen			

\* Standard configuration

**Additional notes:**

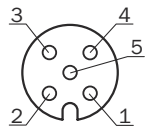
- Max. 1 A output for supply voltage connections (compliant with LPS)
- Data transmission rates:
  - RS-232: 115.2 kBaud
  - RS-422: 2 MBaud
  - RS-485: 2 MBaud
- TTL encoders use RS422 and can be connected via the SERIAL interface.

**6.5.6 FBUS***Figure 13: Fieldbus pin assignment, M12 – 4-pin D-coded, female**Table 7: Fieldbus connections*

Pin	Signal	Function
1	TD+ (TX1_P)	Transmit data +
2	RD+ (RX1_P)	Receive data +
3	TD- (TX1_N)	Transmit data -
4	RD- (RX1_N)	Receive data -
Housing	-	Screen

**Additional notes:**

- Designed for line topology
- Data transmission rates: 10/100 Mbit/s
- PROFINET and EtherNet/IP support

**6.5.7 CAN***Figure 14: CAN pin assignment, M12 – 5-pin A-coded, female**Table 8: CAN connections*

Pin	Signal	Function	Factory settings
1	-	Screen	
2	+24 V	Supply voltage for peripherals, configurable	Deactivated
3	GND	Ground	
4	CAN_H	CAN high	Termination deactivated*
5	CAN_L	CAN low	
Housing	-	Screen	

\* Termination controllable via app

**Additional notes:**

- Max. 3.2 A output for supply voltage connections (compliant with LPS)
- To enable voltage supply to the peripherals, both voltage supply strands from POWER CAN must be connected to 24 V.

## 6.5.8 SENSOR 1-4

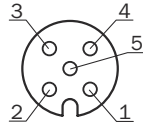


Figure 15: Pin assignment of sensor 1-4, M12 – 5-pin A-coded, female

Table 9: SENSOR 1-4 connections

Pin	Signal	Function	Factory settings
1	+24 V	Supply voltage for peripherals, configurable	Deactivated
2	Input 2	Digital input	–
3	GND	Ground	–
4	C/Q or Input 1 / Output 1	C/Q IO-Link or configurable digital switching input/output	All IO connections configured as inputs
5	NC	Not connected	–
Housing	–	Screen	–

**Additional notes:**

- 4 x IO-Link master (1x master available per connection)
- The digital inputs and output are only switchable if the supply voltage is activated on pin 1, or +24 V is externally applied to pin 1. A ground connection on pin 3 is required in both cases.
- Digital output:
  - Max. output 100 mA.
  - Min. high output logic level: VCC – 3 V
  - Max. low output logic level: 3 V
  - Push-pull switch
  - Max. IO-Link output frequency: 230 kHz
  - Max. IO output frequency: 30 kHz
- Digital inputs:
  - Min. high input logic level: 12 V
  - Max. low input logic level: 4 V
  - Max. IO-Link input frequency: 230 kHz
  - Max. IO input frequency: 30 kHz
- Max. 1 A output for supply voltage connections S1 to S4 (compliant with LPS)
- HTL encoders use push-pull switches and can therefore be connected via the digital inputs.

**Recommendation when using S1 to S4 for illumination:**

- Short flash times can be achieved by using an illumination unit with signal strobe and by using pin 4 as a switching output signal with a constant supply voltage on pin 1.

**External fan:**

A mountable fan guard that is available as an accessory (part number: 2089755) can be connected to S4. This can be used to increase the maximum ambient operating temperature of the device from +50 °C to +60 °C. It is activated via SOPAS-ET or via the GUI of the WelcomeApp of the device. After activation, the fan is automatically switched on or off when the temperature exceeds or falls below a critical temperature.

## 6.5.9 SENSOR 5-8

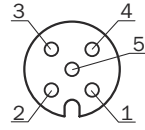
**Illumination control:**

Figure 16: Pin assignment of sensor 5-8, M12 – 5-pin A-coded, female

Table 10: SENSOR 5-8 connections

Pin	Signal	Function	Factory settings
1	+24 V	Supply voltage for peripherals, configurable	Deactivated
2	Input 3	Digital input	–
3	GND	Ground	–
4	Input 1 / output 1	Configurable digital input/output	All IO connections configured as inputs
5	Input 2 / output 2	Configurable digital input/output	All IO connections configured as inputs
Housing	–	Screen	–

**Additional notes:**

- The digital inputs and outputs are only switchable if the supply voltage is activated on pin 1, or +24 V is externally applied to pin 1. A ground connection on pin 3 is required in both cases.
- Digital outputs:
  - Max. output 100 mA
  - Min. high output logic level: VCC – 3 V
  - Max. low output logic level: 3 V
  - Push-pull switch
  - Max. IO output frequency: 30 kHz
- Digital inputs:
  - Min. high input logic level: 12 V
  - Max. low input logic level: 4 V
  - Max. input frequency for input 3: 10 kHz
  - Max. IO input frequency: 30 kHz
- Max. 2.5 A output for supply voltage connections S5 to S8 (compliant with LPS). To enable voltage supply to the peripherals, both voltage supply strands from POWER MAIN must be connected to 24 V.
- HTL encoders use push-pull switches and can therefore be connected via the digital inputs.

**Recommendation when using S5 to S8 for illumination:**

Short flash times can be achieved using two alternative modes:

1. Power Strobe Mode: when using the “Connector.Power.Gate” API (see the API documentation)
2. Signal Strobe Mode: when using pin 4 or pin 5 as a switching output signal with a constant supply voltage on pin 1 (only for illumination units with signal strobe).

## 6.5.10 ETHERNET

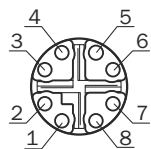


Figure 17: Ethernet pin assignment, M12 – 8-pin X-coded, female

Table 11: Ethernet 1-8 connections

Pin	Function
1	D1+ & DC+ (PoE supply voltage)
2	D1- & DC+ (PoE supply voltage)
3	D2+ & DC- (PoE ground)
4	D2- & DC- (PoE ground)
5	D4+
6	D4-
7	D3-
8	D3+

**Additional notes:**

- The Ethernet connections can be used to connect to cameras and SICK LiDAR scanners as well as a PC or network.
- The relevant drivers for using SICK LiDAR scanners and the picoCam1&2 and midiCam1&2 camera families as well as GigE machine vision compatible cameras have been implemented in the SIM.
- Jumbo frame support is required when using Ethernet switches.
- Transmission rates:
  - ETH1 - 6: 0.01; 0.1, 1 Gb/s
  - ETH7 - 8: 10 Gb/s
- ETH1 – 6: with class 4 PoE Out
  - PoE power supply is activated by factory setting
- To enable voltage supply to PoE devices, both voltage supply strands from POWER MAIN must be connected to 24 V.

## 6.6 Connecting peripheral devices

The device can be connected to a wide range of sensors and cameras.

The required pin assignments can be found in the data sheets for the peripherals to be connected as well as in the relevant connection descriptions, [see "Pin allocation of the connections", page 23](#).

1. If necessary, assemble connection cables, [see "Assembling the cables \(optional\)", page 20](#).
2. Connect the cables to peripheral devices.
3. Route the cables to the device using installation materials (cable channels, cable ties, etc.). When doing so, pay attention to cable strain relief.
4. Connect cables to the relevant device connections and screw together tightly.
5. Seal unused connections with dummy plugs.

## 7 Commissioning

### 7.1 Preparatory commissioning

Commissioning for preparatory purposes and under laboratory conditions differs in some respects from commissioning in the target system.

In general, all safety and hazard warnings applicable to mounting (see ["Mounting", page 15](#)) and electrical installation (see ["Important notes"](#)) must also be observed under laboratory conditions. In addition, further notes must be taken into consideration to guarantee the most effective preparation possible:

- Only connect those devices to the product that you want to configure or program.
- Operate the connected device in a controlled and contained network environment for the time being to check network communication if necessary.
- Note the company standards that apply to the use of checking and testing devices.
- For initial programming, use ideal conditions for sensor or camera recognition.
- Use the largest possible deviations from these ideal conditions to check the programming with respect to its error tolerance and reliability, and to determine error limit values.

#### Procedure

1. Place the device on a non-slip base.
2. Connect the required peripheral devices, see ["Connecting peripheral devices"](#).
3. Connect the network connection.
4. Connect the voltage supply.
5. The device requires a certain start-up time. The readiness is indicated by the green "Dev RDY" LED.

8 Operation







8.1 Status LEDs

When the device is operating, the operational status of the connections is indicated visually by status LEDs.

Using these status indicators, the operator can find out quickly and easily whether the device and the peripherals are working properly or whether any faults or errors have occurred.

Monitoring the visual indicators is part of the routine inspection carried out on the device and the machine/plant area into which the device is incorporated.

Meaning of symbols (applies to all colors)

Symbol	Purpose
	LED off
	LED on
	LED flashes
	LED goes out briefly
	LED lights up briefly
	LED flashes bicolored



### 8.1.1 Situation and function of the LEDs

#### Device status

Table 12: Device status indicators

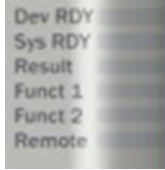








Location	Designation	LED behavior	Indicator
	Dev RDY		Device is booting; power-up time due to boot process (approx. 50 s)
			Runlevel READY, no errors detected.
			Runlevel READY, boot process error.
	Sys RDY Result Funct 1 Funct 2 Remote		User-defined, configurable with AppSpace.
			
			
			
			

Table 13: Device status indicators for PROFINET























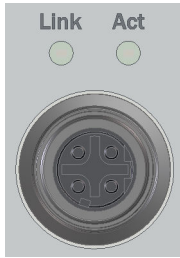




Location	Designation	LED behavior	Description
	SF (system error)		No error
			<b>DCP signal service is triggered via the bus;</b> Device not configured or not configured correctly; Check configuration
			<b>Watchdog timeout;</b> Channel, generic or advanced diagnostics are available; System error
	BF (bus error)		No error
			No data exchange
			No configuration, slow physical connection or no physical connection

Table 14: Device status indicators for EtherNET/IP

Location	Designation	LED behavior	Description
	MS (module status)		<b>Device in operation:</b> The device is in operation and functioning correctly.
			<b>Standby:</b> The device has not been configured.
			<b>Self-test:</b> The device is running a self-test after being switched on.
			<b>Flash sequence:</b> The flash sequence is used to visually identify the device.
			<b>Serious recoverable error</b>
			<b>Serious non-recoverable error</b>
			<b>Switched off:</b> The device is switched off.
	NS (network status)		<b>Connected:</b> An IP address is configured, at least one CIP connection (of an arbitrary transport class) is established
			<b>No connections:</b> An IP address is configured, however no CIP connections have been established
			<b>Flash sequence:</b> The flash sequence is used to visually identify the device.
			<b>Self-test:</b> The device is running a self-test after being switched on
			<b>Timeout of connection:</b> An IP address is configured and the time limit for an exclusive owner connection to the device was exceeded.
			<b>Duplicate IP:</b> The device has detected that its IP address is already in use.
			<b>Switched off, no IP address:</b> The device has no IP address (or is switched off).

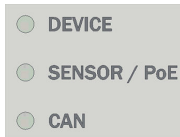



## FBUS

Table 15: Fieldbus status LEDs

Location	Designation	LED behavior	Description
	Link		The device has no connection to the Ethernet
			The device has a connection to the Ethernet
	Act		The device is not sending/receiving Ethernet frames
			The device is sending/receiving Ethernet frames








## POWER

Table 16: Power status LEDs

Location	Designation	LED behavior	Description
	DEVICE SENSOR/ PoE CAN		Voltage not applied to the connection.
			Voltage applied.
			Under/overvoltage detected.








## INC

Table 17: INC status LEDs

Location	Designation	LED behavior	Description
	PWR/ACT		Voltage not applied to the connection.
			Voltage applied. No signal activity.
			Voltage applied. Signal activity.
			Voltage not applied to the connection. Signal activity.
			Overvoltage or short-circuit detected. No signal activity.
			Overvoltage or short-circuit detected. Signal activity.

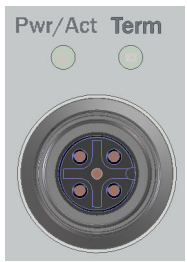








**SERIAL**

Table 18: SERIAL status LEDs

Location	Designation	LED behavior	Description
	PWR/ACT		Voltage not applied to the connection.
			Voltage applied. No signal activity.
			Voltage applied. Signal activity.
			Voltage not applied to the connection. Signal activity.
			Overvoltage or short-circuit detected. No signal activity.
			Overvoltage or short-circuit detected. Signal activity.

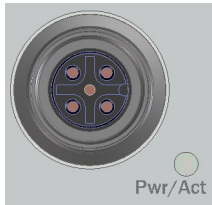






**CAN**

Table 19: CAN status LEDs

Location	Designation	LED behavior	Description
	PWR/ACT		Voltage not applied to the connection.
			Voltage applied. No signal activity.
			Voltage applied. Signal activity.
			Voltage not applied to the connection. Signal activity.
			Overvoltage or short-circuit detected. No signal activity.
			Overvoltage or short-circuit detected. Signal activity.
	Term		Termination resistor not activated.
			Termination resistor activated.

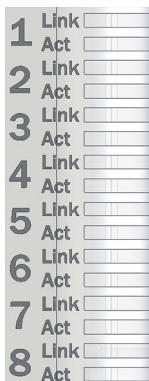












**SENSOR S1 – S8**

Table 20: Sensor status LEDs

Location	Designation	LED behavior	Description
	PWR/ACT		Voltage not applied to the connection.
			Voltage applied. No signal activity.
			Voltage applied. Signal activity.
			Voltage not applied to the connection. Signal activity.
			Overvoltage or short-circuit detected. No signal activity.
			Overvoltage or short-circuit detected. Signal activity.

**ETHERNET 1 - 8**

Table 21: ETHERNET status LEDs

Location	Designation	LED behavior	Description
	Link		Connection not established with Ethernet.
			Connection established with Ethernet.
	Act		No activity.
			Data transmission via Ethernet.
	PoE		ETH1-ETH6 only: Voltage supply via Ethernet.
			ETH1-ETH6 only: Error in supply line (overload, short-circuit)
	PoE		ETH1-ETH6 only: Voltage supply via Ethernet.
			ETH1-ETH6 only: Error in supply line (overload, short-circuit)
	PoE		ETH1-ETH6 only: Voltage supply via Ethernet.
			ETH1-ETH6 only: Error in supply line (overload, short-circuit)
	PoE		ETH1-ETH6 only: Voltage supply via Ethernet.
			ETH1-ETH6 only: Error in supply line (overload, short-circuit)

## 9 Maintenance

### 9.1 Cleaning



#### NOTICE

##### Equipment damage due to improper cleaning.

Improper cleaning may result in equipment damage.

- Only use recommended cleaning agents and tools.
- Never use sharp objects for cleaning.

- ▶ The device must be cleaned regularly from the outside to guarantee heat dissipation and therefore operation. Particular attention must be paid to ensure that the cooling ribs and, if present, the fan are free from dust and dirt. Clean using a dry towel or an industrial vacuum cleaner. Do not use cleaning agents.

### 9.2 Maintenance plan

During operation, the device works maintenance-free.

Depending on the assignment location, the following preventive maintenance tasks may be required for the device at regular intervals:

Table 22: Maintenance plan

Maintenance work	Interval	To be carried out by
Check device and connecting cables for damage at regular intervals.	Depends on ambient conditions and climate.	Specialist
Clean housing.	Depends on ambient conditions and climate.	Specialist
Clean any fans and check their function	Depends on ambient conditions and climate. Recommended: At least every 6 months.	Specialist
Check that all unused connections are sealed with protective caps.	Depends on ambient conditions and climate. Recommended: At least every 6 months.	Specialist

## 10 Decommissioning

### 10.1 Disposal

**CAUTION**

**Risk of injury due to hot device surface.**

The surface of the device can become hot during operation.

- Before performing work on the device (e.g. mounting, cleaning, disassembly), switch off the device and allow it to cool down.
- Ensure good dissipation of excess heat from the device to the surroundings.

If a device can no longer be used, dispose of it in an environmentally friendly manner in accordance with the applicable country-specific waste disposal regulations. Do not dispose of the product along with household waste.

Battery not removable.

**NOTICE**

**Danger to the environment due to improper disposal of the device.**

Disposing of devices improperly may cause damage to the environment.

Therefore, observe the following information:

- Always observe the national regulations on environmental protection.
- Separate the recyclable materials by type and place them in recycling containers.

## 11 Technical data



### NOTE

The relevant online product page for your product, including technical data, dimensional drawing, and connection diagrams, can be downloaded, saved, and printed from the Internet.

The page can be accessed via the **SICK Product ID: [pid.sick.com/{P/N}/{S/N}](http://pid.sick.com/{P/N}/{S/N})**

**{P/N}** corresponds to the part number of the product, see type label.

**{S/N}** corresponds to the serial number of the product, see type label (if indicated).

Please note: This documentation may contain further technical data.

### 11.1 Features

Feature	Parameter
Task	data recording, evaluation, and archiving
Supported devices/ excerpt	2D and 3D cameras from SICK or based on the GigE machine vision standard, encoders, code readers, SICK LiDAR scanners
Technology	Embedded hardware architecture: <ul style="list-style-type: none"> <li>• 16-core PowerPC CPU with AltiVec Velocity Engine</li> <li>• FPGA for image (pre-)processing</li> <li>• FPGA for I/O handling</li> <li>• Dedicated fieldbus controller</li> </ul> Software: <ul style="list-style-type: none"> <li>• Can be programmed within the SICK AppSpace environment</li> <li>• SICK Interface &amp; Algorithm API</li> <li>• Integrated HALCON image processing library</li> </ul>
Random Access Memory	8 GB DDR3
Flash memory	1 GB NAND, 420 MB thereof available for applications
memory card (optional)	Industry-grade microSD memory card (flash card) <b>Supported microSD memory cards:</b> <ul style="list-style-type: none"> <li>• max. 32 GB (SDHC, SD); FAT 12/16/32, EXT 2/3/4</li> </ul>
programming software	SICK AppStudio
Sensor data processing	based on HALCON and/or the SICK Algorithm API

### 11.2 Interfaces

Feature	Parameter
User interfaces	Web server (GUI), SICK AppStudio (programming), SICK AppManager (app installation, firmware update)
Data storage and retrieval	Image and data logging via optional internal SSD, microSD memory card, internal RAM and external FTP
<b>SERIAL (RS-232/RS-422/RS-485)</b>	
Quantity	2, also configurable as an encoder output port
Function	RS-232 / RS-422 / RS-485/ INC In/Out
maximum data transmission rate	RS-232: 115.2 kBaud RS-422: 2 MBaud RS-485: 2 MBaud



Feature	Parameter
<b>INC (incremental)</b>	
Quantity	2, also configurable as RS-422
Function	Incremental encoder (In/OUT), RS-422 interface
Maximum frequency	2 MHz
<b>FBUS (fieldbus)</b>	
Quantity	2
Function	Ethernet-based fieldbus
Data transmission rate	10/100 MBit/s
Protocol	ProfiNet, Ethernet/IP
<b>ETHERNET</b>	
Quantity	8
Function	Data output, configuration, firmware update, 6 x PoE PSE 12 W max.
Data transmission rate	- ETH1 – ETH6: 0.01; 0.1; 1 Gb/s with class 4 PoE - ETH7 – ETH8: 10 Gb/s (without PoE)
Protocol	TCP/IP, FTP (image transfer), OPC-UA, MQTT, GigE machine vision/ GenICAM
<b>CAN</b>	
Quantity	2
Function	SICK CAN sensor network (master/slave, multiplexer/server) with termination resistor which can be activated CAN functional modes: Mode 1: 2 separate CAN networks Mode 2: 1 CAN network with 2x power-out
Data transmission rate	20 kbit/s ... 1 Mbit/s
Protocol	CSN (SICK CAN sensor network)
<b>IO-Link</b>	
Quantity	4 (SENSOR S1 to S4)
Function	IO-Link Master V1.1
Data transmission rate	max. 230 kBaud
<b>Digital switching inputs/outputs</b>	
I/O	Inputs: 4 opto-decoupled, max. frequency: 30 kHz Inputs/outputs: 7 (configurable), max. frequency: 30 kHz
SENSOR S1-S4	Inputs: 1 each, max. frequency: 30 kHz Inputs/outputs: 1 each (configurable), max. frequency: 30 kHz
SENSOR S5-S8	Inputs: 1 each, max. frequency: 10 kHz Inputs/outputs: 2 each (configurable), max. frequency: 30 kHz
USB	USB 2.0 for configuration, diagnostics, firmware update

### 11.3 Mechanics and electronics

Feature	Parameter
Operating elements	1 selector switch, 1 function button (under the servicing panel)

Feature	Parameter
Electrical connection	I/O: 1 x M12, 17-pin female connector, A-coded POWER MAIN and CAN: 2 x M12, 4-pin male connector, T-coded INC: 2 x M12, 8-pin female connector, A-coded SERIAL: 2 x M12, 8-pin female connector, A-coded FBUS: 2 x M12, 4-pin female connector, D-coded CAN: 2 x M12, 5-pin female connector, A-coded SENSOR S1–S4, IO-Link master: 4 x M12, 5-pin female connector, A-coded SENSOR S5–S8: 4 x M12, 5-pin female connector, A-coded Ethernet GigE with POE: 6 x M12, 8-pin female connector, X-coded Ethernet 10GigE: 2x M12, 8-pin female connector, X-coded USB: Micro-B
Operating voltage	24 V DC, $\pm 10\%$ SELV in accordance with EN 61010, also applies to digital inputs
Operating current	Must be limited by external power supply unit to max. 16 A
Power consumption	60 W type, without connected sensors
Power output	Total 300 W max. (all connections)
Output current	
SENSOR S1-S8, I/O	$\leq 100$ mA, on digital output pins
SENSOR S1-S4	$\leq 1$ A, on power supply pins
SENSOR S5-S8	$\leq 2.5$ A, on power supply pins Switching times when using the "Connector.Power.Gate" API: rise time/fall time/delay $< 10$ $\mu$ s, max. frequency: 10 kHz
CAN	$\leq 3.2$ A, on power supply pins
SERIAL	$\leq 1$ A, on power supply pins
INC	$\leq 0.5$ A, on power supply pins
I/O	$\leq 500$ mA, on power supply pins
Battery	Type: TL-2450; 3.7 V; firmly soldered; not rechargeable Chemical system: Lithium thionyl chloride (Li-SOCl <sub>2</sub> )
Housing material	Aluminum die cast
Housing color	Light blue (RAL 5012) with gray-white front foil (RAL 9002)
Protection class	III
Weight	5120 g
Dimensions (W x D x H)	164.5 x 147 x 272 mm

## 11.4 Ambient data

Feature	Parameter
Electromagnetic compatibility (EMC)	EN 61000-6-2:2005-08 EN 61000-6-4:2007 + A1:2011 EN 61131-9:2013-12
Shock resistance	EN 60068-2-6
Electrical safety	IEC 61010-1:2010 + Cor.: 2011 IEC 61010-2-201:2017
Enclosure rating	IP65 in accordance with EN 60529-2000-09 (requires blind plugs to be inserted into unused connections)
Ambient conditions	

Feature	Parameter
Operation site Height position Degree of contamination	Use inside buildings max. 2,000 m 1
Ambient operating temperature	0 °C ... +50 °C, when the described mounting requirements are taken into account, <a href="#">see "Mounting the device (at a critical ambient temperature of max. 50 °C)", page 17</a>
Storage temperature	-20 °C ... +70 °C
Permissible relative humidity	90%, non-condensing

## 12 Annex

## 12.1 Dimensional drawings

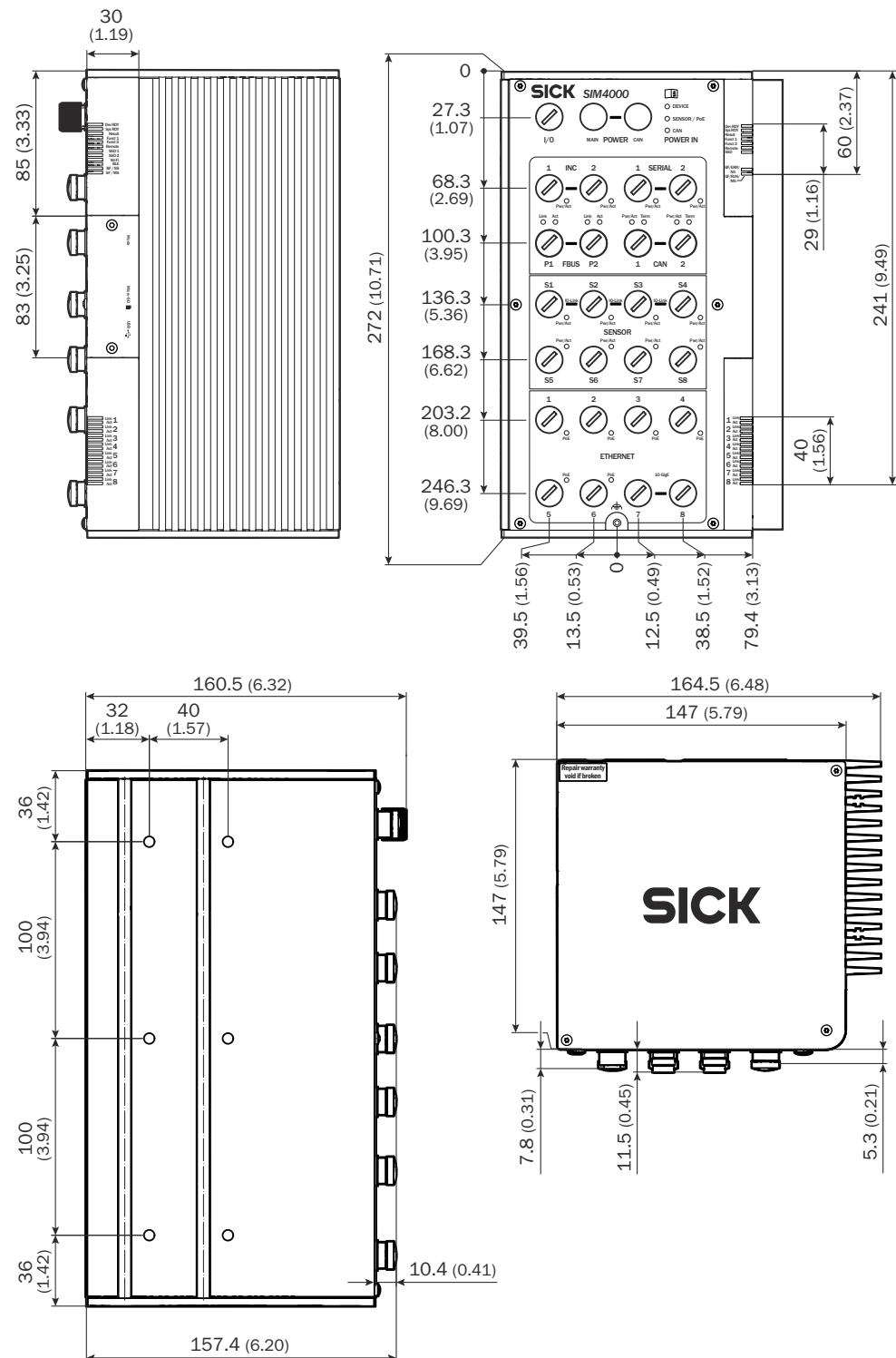


Figure 18: Dimensions of the SIM4000, unit: mm (inch), decimal separator: period

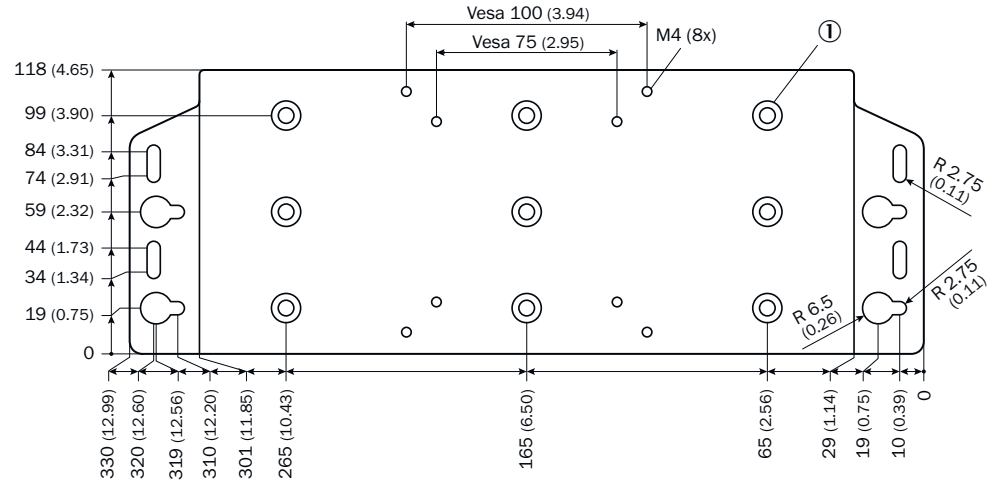
**Adapter holding plate (available as accessory)**

Figure 19: Dimensions of the adapter mounting plate, unit: mm (inch), decimal separator: period

① Counterbore M5 (9x)

## 12.2 Licenses

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**Australia**  
Phone +61 (3) 9457 0600  
1800 33 48 02 – tollfree  
E-Mail sales@sick.com.au

**Austria**  
Phone +43 (0) 2 236 62288-0  
E-Mail office@sick.at

**Belgium/Luxembourg**  
Phone +32 (0) 2 466 55 66  
E-Mail info@sick.be

**Brazil**  
Phone +55 11 3215-4900  
E-Mail comercial@sick.com.br

**Canada**  
Phone +1 905.771.1444  
E-Mail cs.canada@sick.com

**Czech Republic**  
Phone +420 234 719 500  
E-Mail sick@sick.cz

**Chile**  
Phone +56 (2) 2274 7430  
E-Mail chile@sick.com

**China**  
Phone +86 20 2882 3600  
E-Mail info.china@sick.net.cn

**Denmark**  
Phone +45 45 82 64 00  
E-Mail sick@sick.dk

**Finland**  
Phone +358-9-25 15 800  
E-Mail sick@sick.fi

**France**  
Phone +33 1 64 62 35 00  
E-Mail info@sick.fr

**Germany**  
Phone +49 (0) 2 11 53 010  
E-Mail info@sick.de

**Greece**  
Phone +30 210 6825100  
E-Mail office@sick.com.gr

**Hong Kong**  
Phone +852 2153 6300  
E-Mail ghk@sick.com.hk

**Hungary**  
Phone +36 1 371 2680  
E-Mail ertesites@sick.hu

**India**  
Phone +91-22-6119 8900  
E-Mail info@sick-india.com

**Israel**  
Phone +972 97110 11  
E-Mail info@sick-sensors.com

**Italy**  
Phone +39 02 27 43 41  
E-Mail info@sick.it

**Japan**  
Phone +81 3 5309 2112  
E-Mail support@sick.jp

**Malaysia**  
Phone +603-8080 7425  
E-Mail enquiry.my@sick.com

**Mexico**  
Phone +52 (472) 748 9451  
E-Mail mexico@sick.com

**Netherlands**  
Phone +31 (0) 30 229 25 44  
E-Mail info@sick.nl

**New Zealand**  
Phone +64 9 415 0459  
0800 222 278 – tollfree  
E-Mail sales@sick.co.nz

**Norway**  
Phone +47 67 81 50 00  
E-Mail sick@sick.no

**Poland**  
Phone +48 22 539 41 00  
E-Mail info@sick.pl

**Romania**  
Phone +40 356-17 11 20  
E-Mail office@sick.ro

**Russia**  
Phone +7 495 283 09 90  
E-Mail info@sick.ru

**Singapore**  
Phone +65 6744 3732  
E-Mail sales.gsg@sick.com

**Slovakia**  
Phone +421 482 901 201  
E-Mail mail@sick-sk.sk

**Slovenia**  
Phone +386 591 78849  
E-Mail office@sick.si

**South Africa**  
Phone +27 10 060 0550  
E-Mail info@sickautomation.co.za

**South Korea**  
Phone +82 2 786 6321/4  
E-Mail infokorea@sick.com

**Spain**  
Phone +34 93 480 31 00  
E-Mail info@sick.es

**Sweden**  
Phone +46 10 110 10 00  
E-Mail info@sick.se

**Switzerland**  
Phone +41 41 619 29 39  
E-Mail contact@sick.ch

**Taiwan**  
Phone +886-2-2375-6288  
E-Mail sales@sick.com.tw

**Thailand**  
Phone +66 2 645 0009  
E-Mail marcom.th@sick.com

**Turkey**  
Phone +90 (216) 528 50 00  
E-Mail info@sick.com.tr

**United Arab Emirates**  
Phone +971 (0) 4 88 65 878  
E-Mail contact@sick.ae

**United Kingdom**  
Phone +44 (0)17278 31121  
E-Mail info@sick.co.uk

**USA**  
Phone +1 800.325.7425  
E-Mail info@sick.com

**Vietnam**  
Phone +65 6744 3732  
E-Mail sales.gsg@sick.com

Detailed addresses and further locations at [www.sick.com](http://www.sick.com)